

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	"20040150118"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:04
L2	904410	(semiconductor chip die ic flipchip (flip adj chip) (integrated adj circuit) compoenent electronic) with (substrate carrier pcb ((printed circuit wiring) adj5 board) board)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:02
L3	208472	(stiffener stiffening block stud cu copper alumina silicon aluminum (aluminum adj nitride) aln resin) with (surround surrounding surrounded peripheral peripherally)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:10
L4	9283	2 same 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:11
L5	2874	resin same 4	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:11
L6	654	(lid cover top) same 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:29
L7	705	(lid cover cap top) same 5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:02
L8	51	7 not 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 18:29
L9	1	"5629566".PN.	USPAT; USOCR	OR	OFF	2005/10/12 18:34

L10	1	"5930598".PN.	USPAT; USOCR	OR	OFF	2005/10/12 18:34
L11	1	"5386342".PN.	USPAT; USOCR	OR	OFF	2005/10/12 18:41
L12	46836	(lid cover cap top) same 3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:02
L13	1999	12 same 2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:03
L14	1345	13 not 6	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:04
L15	12	14 same (fillet underfill underfillet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:04
L16	70	14 and (fillet underfill underfillet)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/10/12 19:05